

The data collected will be kept confidential and used by the Hongkong Bank Foundation/HSBC to process the scholarship application.

**HSBC OVERSEAS SCHOLARSHIP 2024/25
STUDENT UNDERTAKING FORM**

To be completed by applicant and guarantor/s

To: _____
(name of university in Hong Kong)

In consideration of your awarding me the HSBC Overseas Scholarship, I,

_____,
(name in English)
, the undersigned, hereby declare that the information I have submitted to the _____
(name in Chinese)

_____ and _____
(name of university in Hong Kong) *(name of university outside Hong Kong)*
is accurate and I have no overseas residency / extensive studying experience.

In addition, I understand that the Scholarship will go towards tuition fees, a minimum economy return airfare, reasonable room and board costs, books and a small portion of living expenses, and I agree to:

- 1) Abide by the policies and requirements of both the local and overseas universities;
- 2) ***Participate in and complete the Hong Kong Young Ambassador Scheme***, a three-week full-time summer programme from mid-July to early August, organised by the Tourism Commission of the Hong Kong Special Administration Region Government and The Hong Kong Federation of Youth Groups, and to act as a goodwill ambassador for Hong Kong while abroad, ***or*** participate in an alternate programme similar to the Hong Kong Young Ambassador Scheme, with prior written approval from HSBC; and
- 3) Participate actively in campus life and the community while overseas.

Signed by

(Applicant)

In the presence of

(Signature of Witness)
(must be different from Guarantor)

To be completed by Guarantor/s

In consideration of your accepting the above Undertaking from the applicant for the purposes stated thereon, I/we, the undersigned, hereby guarantee the due performance by the applicant of the Undertaking.

(Signature of Guarantor/s)

Name/s: _____

Name: _____

Relationship: _____

Address: _____

Address: _____

Date: _____

Date: _____